imall

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OCMOS FET PS7122A-1C,PS7122AL-1C

8-PIN DIP, 250 V BREAK DOWN VOLTAGE **TRANSFER TYPE**

-NEPOC Series-

Solid State Relay

2-ch Optical Coupled MOS FET

DESCRIPTION

The PS7122A-1C and PS7122AL-1C are transfer type solid state relays containing normally open (N.O.) contact and normally close (N.C.) contact on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7122AL-1C has a surface mount type lead.

FEATURES

- 2 channel type (1 a + 1 b output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer •
- Small package (8-pin DIP) •
- · Low offset voltage
- Ordering number of taping product: PS7122AL-1C-E3, E4: 1 000 pcs/reel

<R>

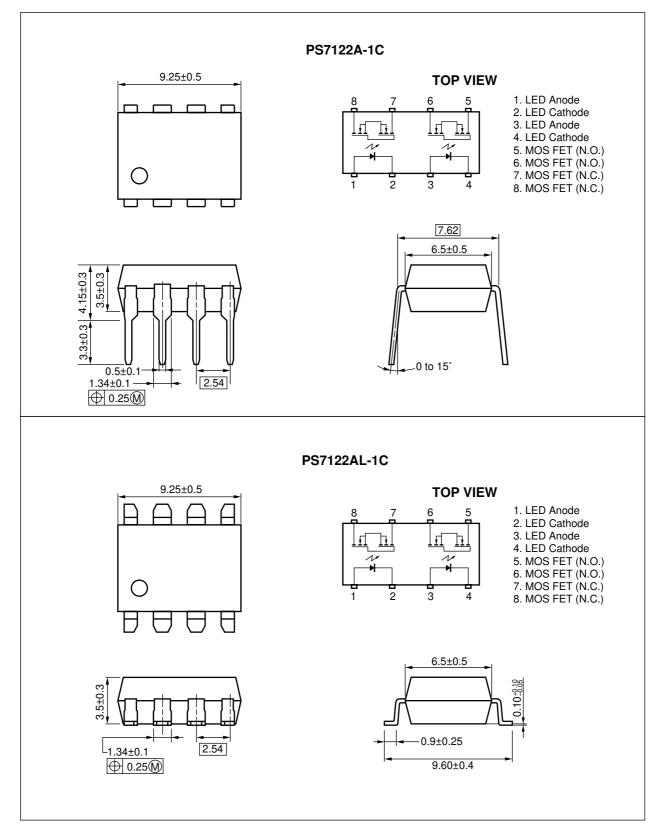
- · Pb-Free product <R> · Safety standards
 - UL approved: File No. E72422
 - BSI approved: No. 8245/8246
 - CSA approved: No. CA 101391

APPLICATIONS

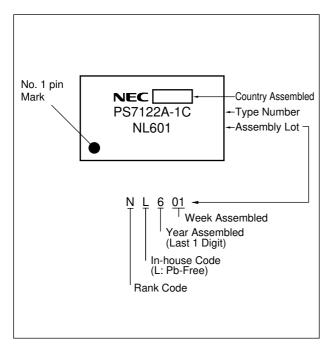
- Exchange equipment
- Measurement equipment
- FA/OA equipment

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PACKAGE DIMENSIONS (in millimeters)



<R> MARKING EXAMPLE



<R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number ^{*1}
PS7122A-1C	PS7122A-1C-A	Pb-Free	Magazine case 50 pcs	Standard products	PS7122A-1C
PS7122AL-1C	PS7122AL-1C-A			(UL, BSI, CSA	
PS7122AL-1C-E3	PS7122AL-1C-E3-A		Embossed Tape 1 000 pcs/reel	approved)	
PS7122AL-1C-E4	PS7122AL-1C-E4-A				

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	50	mA/ch
	Reverse Voltage	VR	5.0	V
	Power Dissipation	PD	50	mW/ch
	Peak Forward Current ^{*1}	I FP	1	A/ch
MOS FET	Break Down Voltage	VL	250	V
	Continuous Load Current	١L	200	mA/ch
	Pulse Load Current ^{*2} (AC/DC Connection)	LP	400	mA/ch
	Power Dissipation	PD	375	mW/ch
Isolation Voltage *3		BV	1 500	Vr.m.s.
Total Power Dissipation		Ρτ	850	mW
Operating Ambient Temperature		TA	–40 to +85	°C
Storage Temperature		Tstg	-40 to +100	°C

*1 PW = 100 μ s, Duty Cycle = 1%

*2 PW = 100 ms, 1 shot

*3 AC voltage for 1 minute at $T_A = 25^{\circ}C$, RH = 60% between input and output Pins 1-4 shorted together, 5-8 shorted together.

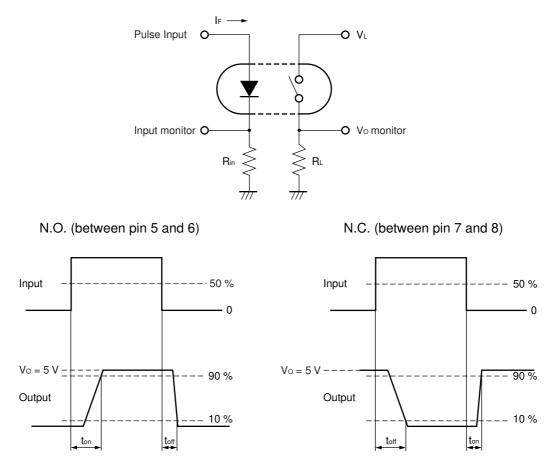
RECOMMENDED OPERATING CONDITIONS (TA = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

ELECTRICAL CHARACTERISTICS (TA = 25°C)

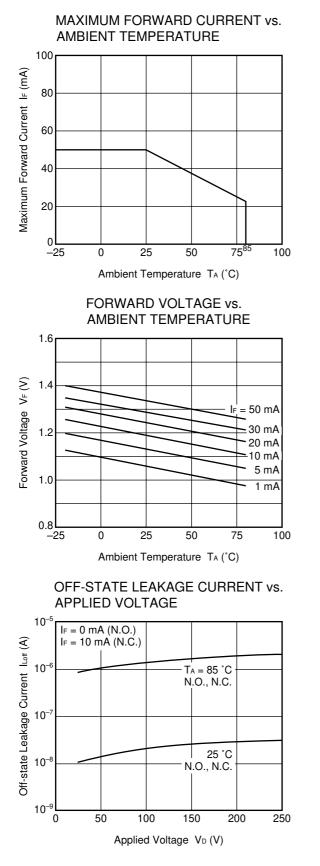
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	IR	V _R = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	Loff	N.O.: IF = 0 mA, VD = 250 V		0.03	1.0	μA
			N.C.: IF = 10 mA, VD = 250 V				
	Output Capacitance	Cout	N.O.: V _D = 0 V, f = 1 MHz		120		pF/ch
			N.C.: IF = 10 mA, VD = 0 V, f = 1 MHz		340		
Coupled	LED On-state Current	IFon	N.O.: I∟ = 200 mA			2.0	mA
	LED Off-state Current	Foff	N.C.: I∟ = 200 mA			2.0	mA
	On-state Resistance	Ron1	N.O.: I⊧ = 10 mA, I∟ = 10 mA		4.5	8.0	Ω
			N.C.: IF = 0 mA, IL = 10 mA				
		Ron2	N.O.: IF = 10 mA, IL = 200 mA, t \leq 10 ms				
			N.C.: IF = 0 mA, IL = 200 mA, t \leq 10 ms				
	Turn-on Time *1, 2	ton (N.O.)	$I_F = 10 \ mA, \ V_O = 5 \ V, \ R_L = 500 \ \Omega,$		0.5	1.5	ms
		ton (N.C.)	PW ≥ 10 ms		0.04	0.2	
	Turn-off Time *1, 2	toff (N.O.)			0.04	0.2	
		toff (N.C.)			0.5	1.5	
	Isolation Resistance	R⊦o	VI-O = 1.0 kVDC	10 ⁹			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		1.1		pF/ch

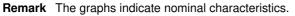
*1 Test Circuit for Switching Time

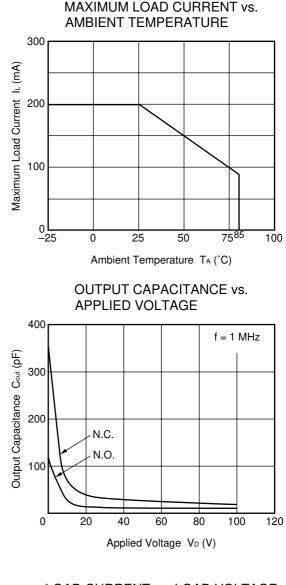


<R> *2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms. Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

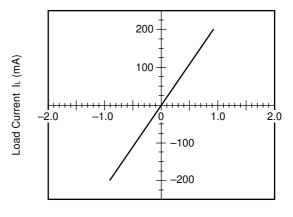
TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)





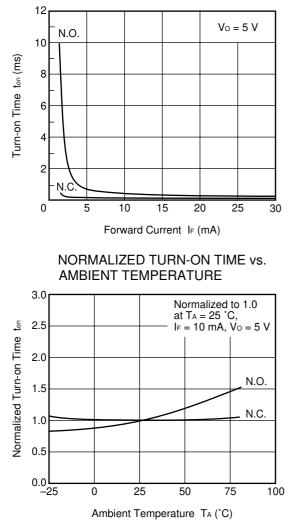


LOAD CURRENT vs. LOAD VOLTAGE

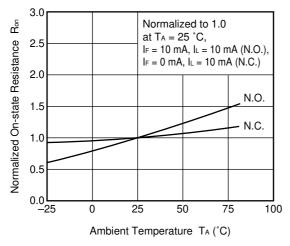


Load Voltage $V_{L}(V)$

TURN-ON TIME vs. FORWARD CURRENT

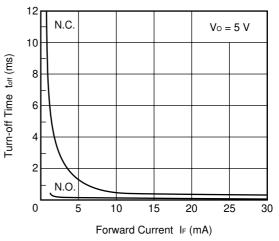


NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE

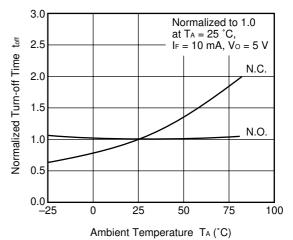


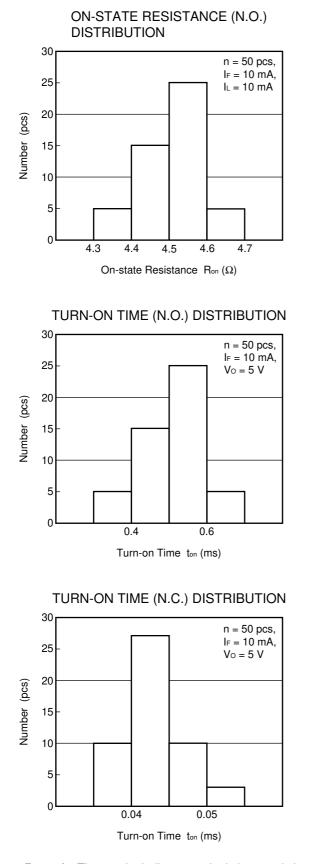
Remark The graphs indicate nominal characteristics.

TURN-OFF TIME vs. FORWARD CURRENT



NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE





Remark The graphs indicate nominal characteristics.

ON-STATE RESISTANCE (N.C.) DISTRIBUTION n = 50 pcs, $l \in 0 \text{ mA},$ $l \perp = 10 \text{ mA}$ $l \perp = 10 \text{ mA}$

4.3

4.4

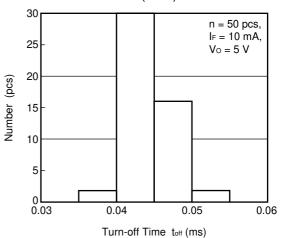
TURN-OFF TIME (N.O.) DISTRIBUTION

4.5

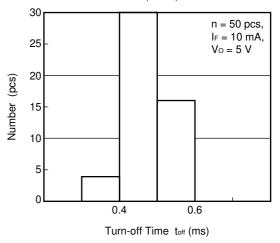
On-state Resistance $R_{on}(\Omega)$

4.6

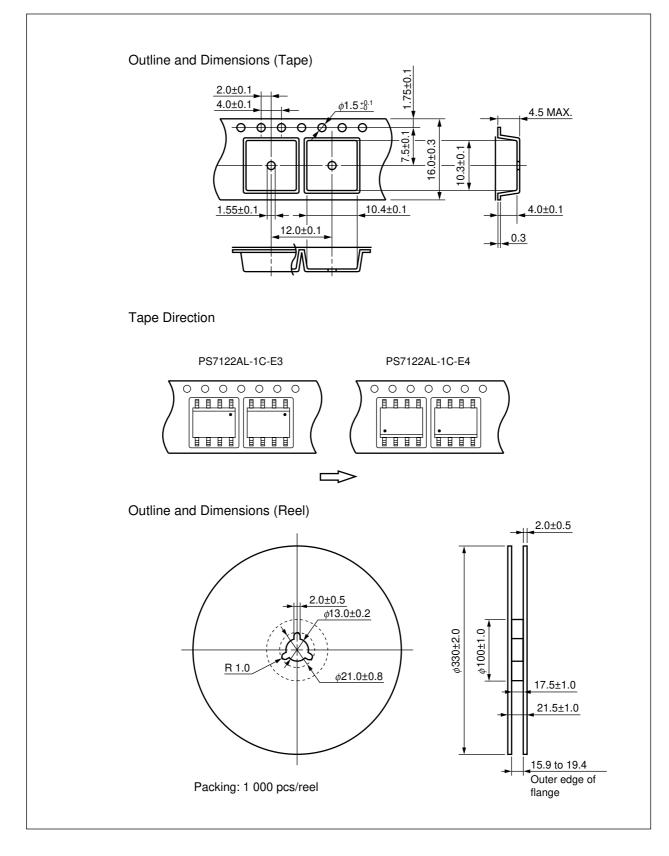
4.7



TURN-OFF TIME (N.C.) DISTRIBUTION



TAPING SPECIFICATIONS (in millimeters)



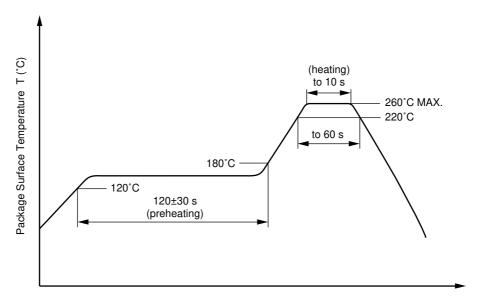
RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 	260°C or below (molten solder temperature)
---------------------------------	--

- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times
 One
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

<R> (3) Soldering by soldering iron

350°C or below
3 seconds or less
Rosin flux containing small amount of chlorine (The flux with a
maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

<R> USAGE CAUTIONS

- **1.** Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.

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